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FOR UTILITY/DESIGN CIP/PCT NATIONAL/PLANT ORIGINAL/SUBSTITUTE/SUPPLEMENTAL **DECLARATIONS**

RULE 63 (37 C.F.R. DECLARATION AND FOWER CONTORNEY FOR PATENT APPLICATION IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

PM & S **FORM**

beli ve I am th original, first and sole inventor (if only on name is list d below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the INVENTION ENTITLED POWER SEMICONDUCTOR DEVICE AND PRODUCTION METHOD FOR THE SAME th specification of which (CHECK applicabl BOX(ES)) → A. 🛛 is attached hereto. X BOX(ES) → B. 🔲 was filed on as U.S. Application No. → C. was filed as PCT International Application No. PCT/ on and (if applicable to U.S. or PCT application) was amended on I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose all information known to me to be material to patentability as defined in 37 C.F.R. 1.56. I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or 365(b) of any foreign application(s) for patent or inventor's certificate, or 365(a) of any PCT International Application which designated at least one other country than the United States, listed below and have also identified below any foreign application for patent or inventor's certificate, or PCT International Application, filed by me or my assignee disclosing the subject matter claimed in this application and having a filing date (1) before that of the application on which priority is claimed, or (2) if no priority claimed, before the filing date of this application: PRIOR FOREIGN APPLICATION(S) Date first Laid-**Date Patented** Priority Claimed Number Day/MONTH/Year Filed Country open or Published or Granted <u>Yes</u> <u>No</u> HEI 11-262861 Japan 17/9/1999 X I hereby claim domestic priority benefit under 35 U.S.C. 119(e) or 120 and 365(c) of the indicated United States applications listed below and PCT international applications listed above or below and, if this is a continuation-in-part (CIP) application, insofar as the subject matter disclosed and claimed in this application is in addition to that disclosed in such prior applications, I acknowledge the duty to disclose all information known to me to be material to patentability as defined in 37 C.F.R. 1.56 which became available between the filing date of each such prior application and the national or PCT international filing date of this application: PRIOR U.S. PROVISIONAL, NONPROVISIONAL AND/OR PCT APPLICATION(S) **Priority Claimed** <u>Status</u> Application No. (series code/serial no.) Day/MONTH/Year Filed pending, abandoned, patented Yes No I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. And I hereby appoint Pillsbury Madison & Sutro LLP, Intellectual Property Group, 1100 New York Avenue, N.W., Ninth Floor, East Tower, Washington, D.C. 20005-3918, telephone number (202) 861-3000 (to whom all communications are to be directed), and the below-named persons (of the same address) individually and collectively my attorneys to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith and with the resulting patent, and I hereby authorize them to delete names/numbers below of persons no longer with their firm and to act and rely on instructions from and communicate directly with the person/assignee/attorney/firm/ organization who/which first sends/sent this case to them and by whom/which I hereby declare that I have consented after full disclosure to be represented unless/until I instruct the above Firm and/or a below attorney in writing to the contrary. Paul N. Kokulis 16773 Dale S. Lazar Mark G. Paulson 28872 Michael R. Dzwonczyk 30793 Raymond F. Lippitt 36787 Paul E. White, Jr. 17519 Stephen C. Glazier 32011 31361 W. Patrick Bengtsson 32456 G. Lloyd Knight 17698 Glenn J. Perry Paul F. McQuade 28458 31542 Jack S. Barufka 37087 Carl G. Love Kendrew H. Colton 18781 30368 Ruth N. Morduch 31044 Adam R. Hess 41835 K vin E. Joyce 20508 G. Paul Edgell 24238 Richard H. Zaitlen 27248 G orge M. Sirilla 18221 Lynn E. Eccleston 35861 Roger R. Wise 31204 Donald J. Bird 25323 Timothy J. Klima 34852 Jay M. Finkelstein 21082 Peter W. Gowdey 25872 David A. Jakopin Anita M. Kirkpatrick 32995 32617 (1) INVENTOR'S SIGNATURE: August 24, 2000 Date: Kimimori Hamada First County Tipe 1975 Middle Initial Family Name Tovota-shi R sidence Aichi-ken Japan City State/Foreign Country Country of Citizenship c/o TOYOTA JIDOSHA KABUSHIKI KAISHA of 1, Post Office Address Toyota-cho, Toyota-shi, (includ Zip Code) Aichi-ken, 471-18571 Japan (2) INVENTOR'S SIGNATURE: Date: First Family Name Middle Initial Residence City State/Foreign Country Country of Citizenship Post Office Address (include Zip Code) (FOR ADDITIONAL INVENTORS, check box ☐ to attach PAT 116-2 same information for each re signature, name, date, citizenship, residence and address.)

As a below named inventor, I hereby declare that my resid nce, post office address and citizenship are as stated below next to my nam, and I